

**APPLICATION DATA SHEET****Application Information**

Application Type:: Regular  
Subject Matter:: Utility  
CD-ROM or CD-R?:: No  
Number of CD Disks:: 0  
Number of Copies of CDs:: 0  
Sequence Submission?:: No  
Computer Readable Form (CRF)?:: No  
Number of Copies of CRF:: 0  
Title:: System and Method to Reduce Metal  
Series Resistance of Bumped Chip  
Attorney Docket Number:: GWS-005  
Request for Early Publication?:: No  
Request for Non-Publication?:: No  
Suggested Drawing Figure::  
Total Drawing Sheets:: 5  
Small Entity?:: No  
Licensed US Govt. Agency:: No  
Contract or Grant Numbers::  
Secrecy Order in Parent Appl.?:: No

**Applicant Information**

Applicant Authority Type:: Inventor  
Primary Citizenship Country:: U.S.  
Status:: Full Capacity  
Given Name:: David  
Middle Name:: N.  
Family Name:: Okada  
Name Suffix::  
City of Residence:: Chandler  
State or Province of Residence:: Arizona  
Country of Residence:: U.S.

Street of Mailing Address:: 5681 W. Park Ave.  
City of Mailing Address:: Chandler  
State or Province of Mailing Address:: Arizona  
Country of Mailing Address:: U.S.  
Postal or Zip Code of Mailing Address:: 85226

**Correspondence Information**

Correspondence Customer Number:: 051414

**Representative Information**

Representative Customer Number:: 051414

**Domestic Priority Information**

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This application	National Stage of	PCT/US2004/040698	12/03/04
PCT/US2004/040698	Claims priority to	60/527,463	04/12/03

**Foreign Priority Information**

Country::	Application Number::	Filing Date::	Priority Claimed::
		MM/DD/YY	

**Assignee Information**

Assignee Name:: Great Wall Semiconductor Corporation  
City of Mailing Address:: Tempe  
State or Province of Mailing Address:: Arizona  
Country of Mailing Address:: U.S.A.